SDLS043 - DECEMBER 1983 - REVISED MARCH 1988

- D-C Triggered from Active-High or Active-Low Gated Logic Inputs
- Retriggerable for Very Long Output Pulses, Up to 100% Duty Cycle
- Overriding Clear Terminates Output Pulse
- '122 and 'LS122 Have Internal Timing Resistors

#### description

These d-c triggered multivibrators feature output pulse-duration control by three methods. The basic pulse time is programmed by selection of external resistance and capacitance values (see typical application data). The '122 and 'LS122 have internal timing resistors that allow the circuits to be used with only an external capacitor, if so desired. Once triggered, the basic pulse duration may be extended by retriggering the gated low-level-active (A) or high-level-active (B) inputs, or be reduced by use of the overriding clear. Figure 1 illustrates pulse control by retriggering and early clear.

The 'LS122 and 'LS123 are provided enough Schmitt hysteresis to ensure jitter-free triggering from the B input with transition rates as slow as 0.1 millivolt per nanosecond.

The  $R_{\mbox{\scriptsize int}}$  in nominall 10  $k\Omega$  for '122 and 'LS122.

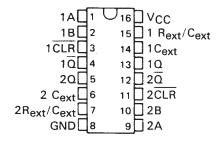
SN54122, SN54LS122...J OR W PACKAGE SN74122...N PACKAGE SN74LS122...D OR N PACKAGE (TOP VIEW) (SEE NOTES 1 THRU 4)

A1 🗆	1	<u> 14</u>		Vcc
A2 [	2	13		R <sub>ext</sub> /C <sub>ext</sub>
B1 □	3	12	þ	NC
B2 ☐	4	11		C <sub>ext</sub>
CLR	5	10		NC
₫□	6	9		Rint
GND□	7	8		Q

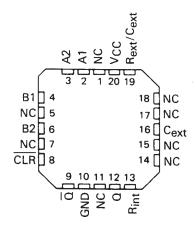
NOTES: 1. An external timing capacitor may be connected between  $C_{\text{ext}}$  and  $\text{Re}_{\text{xt}}/C_{\text{ext}}$  (positive).

- To use the internal timing resistor of '122 or 'LS122, connect R<sub>int</sub> to V<sub>CC</sub>.
- For improved pulse duration accuracy and repeatability, connect an external resistor between Rext/Cext and VCC with Rint open-circuited.
- To obtain variable pulse durations, connect an external variable resistance between R<sub>int</sub> or R<sub>ext</sub>/C<sub>ext</sub> and VCC.

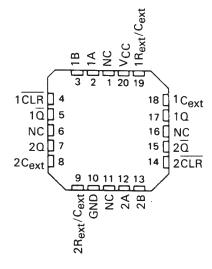
SN54123, SN54130, SN54LS123...J OR W PACKAGE SN74123, SN74130...N PACKAGE SN74LS123...D OR N PACKAGE (TOP VIEW) (SEE NOTES 1 THRU 4)



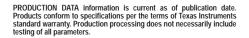
SN54LS122 . . . FK PACKAGE (TOP VIEW) (SEE NOTES 1 THRU 4)



SN54LS123 . . . FK PACKAGE (TOP VIEW) (SEE NOTES 1 THRU 4)



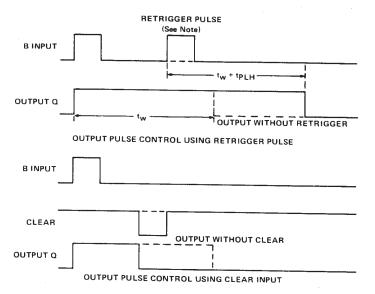
NC - No internal connection





SDLS043 - DECEMBER 1983 - REVISED MARCH 1988

#### description (continued)



NOTE: Retrigger pulses starting before 0.22 C<sub>ext</sub> (in picofrads) nanoseconds after the initial trigger pulse will be ignored and the output duration will remain unchanged.

#### FIGURE 1-TYPICAL INPUT/OUTPUT PULSES

'122, 'L\$122 FUNCTION TABLE

	INP	JTS			OUT	UTS
CLEAR	Α1	A2	В1	<b>B2</b>	Q	ā
L	Х	X	Х	Х	L	Н
×	н	Н	Х	×	L†	нŤ
×	Х	X	L	Х	L†	н†
×	Х	Х	Х	L	L†	нŤ
н	L	Х	1	Н	Λ	U
н	L	Χ	Н	1	Л	IJ
н	Х	L	<b>↑</b>	Н	7.	v
н	Х	L	Н	<b>†</b>	Л	U
н	Н	1	Н	Н	V	IJ
н	1	$\downarrow$	Н	н	V	J.
н	1	Н	Н	н	Л	u
1	L	X	Н	н	7	U
_ †	×	L	Н	н	7	v

'123, '130, 'LS123 FUNCTION TABLE

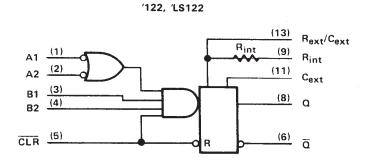
INPL	JTS		оит	PUTS
CLEAR	Α	В	α	ā
L	Х	X	L	Н
×	Н	X	L†	н†
Х	х	L	L†	нŤ
Н	L	<b>†</b>	Л	U
Н	ţ	Н	Л	U
1	L	Н	7	v

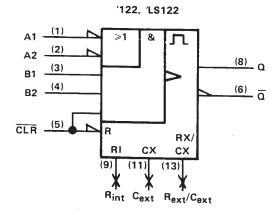
See explanation of function tables on page

† These lines of the functional tables assume that the indicated steady-state conditions at the A and B inputs have been set up long enough to complete any pulse started before the set up.

#### logic diagram (positive logic)

#### logic symbol†

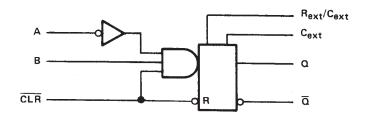




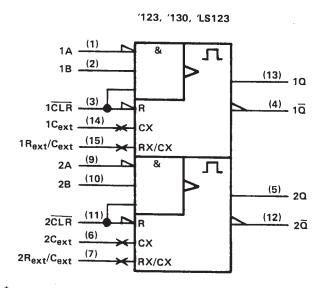
 $R_{\mbox{\scriptsize int}}$  is nominally 10  $k\Omega$  for '122 and 'LS122

## logic diagram (positive logic) (each multivibrator)

'123, '130, 'L\$123



# logic symbol†



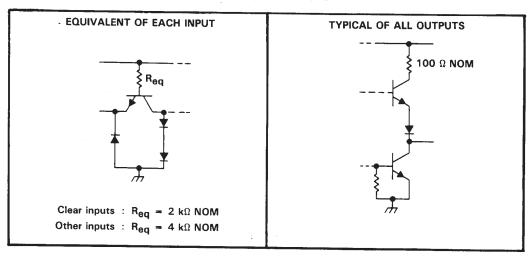
Pin numbers shown are for D, J, N, and W packages.

<sup>†</sup>These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

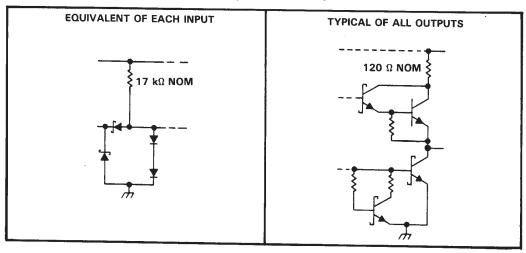
SDLS043 - DECEMBER 1983 - REVISED MARCH 1988

#### schematics of inputs and outputs

'122, '123, '130 CIRCUITS



'LS122, 'LS123 CIRCUITS



# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	17
Input voltage: '122, '123, '130	٧.
(1912) (1912)	V
'LS122, 'LS123	V
operating free-air temperature range: SN54'	C
SN74'	20
Storage temperature range65°C to 150°	,C

NOTE 1: Voltage values are with respect to network ground terminal.



#### recommended operating conditions

		SN54'			SN74'		
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC</sub>	4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH			-800			800	μА
Low-level output current, IOL			16			16	mA
Pulse duration, t <sub>W</sub>	40			40			ns
External timing resistance, R <sub>ext</sub>	5		25	5		50	kΩ
External capacitance, C <sub>ext</sub>		restrict			restrict		1,00
Wiring capacitance at R <sub>ext</sub> /C <sub>ext</sub> terminal			50	140	710311101	50	
Operating free-air temperature, TA	-55		125	0		70	pF °C

# electrical characteristics over recommended free-air operating temperature range (unless otherwise noted)

	PARAMETER		TEST CO	NDITIONS†		122			<b>123, 113</b>	30	
			120100	- TONG	MIN	TYP#	MAX	MIN	TYP±	MAX	UNIT
VIH	High-level input voltage				2	· · · ·		2			V
VIL	Low-level input voltage						0.8			0.8	l v
VIK	Input clamp voltage		VCC = MIN,	$I_1 = -12 \text{ mA}$			-1.5			-1.5	V
Vон	High-level output voltage		V <sub>CC</sub> = MIN, See Note 5	$I_{OH} = -800 \mu\text{A},$	2.4	3.4	1.5	2.4	3.4	-1.5	V
VoL	Low-level output voltage		V <sub>CC</sub> = MIN, See Note 5	IOL = 16 mA,		0.2	0.4		0.2	0.4	V
11	Input current at maximum i	nput voltage	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 5.5 V			1			1	mA
Ιн	High-level input current	Data inputs	V <sub>CC</sub> = MAX,	V 2 4 V			40	_		40	1117
		Clear input	VCC - WAX,	V   - 2,4 V			80			80	μΑ
HE	Low-level input current	Data inputs	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0.4.V			-1.6			-1.6	
		Clear input	VCC WAX,	V   - 0.4 V			-3.2			-3.2	mA
los	Short-circuit output current	3	VCC = MAX,	See Note 5	-10		-40	-10		-40	mΑ
Icc	Supply current (quiescent o	r triggered)	V <sub>CC</sub> = MAX,	See Notes 6 and 7		23	36	<del></del>	46	66	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTES: 5. Ground  $C_{\text{ext}}$  to measure  $V_{\text{OH}}$  at Q,  $V_{\text{OL}}$  at  $\overline{Q}$ , or  $I_{\text{OS}}$  at Q.  $C_{\text{ext}}$  is open to measure  $V_{\text{OH}}$  at  $\overline{Q}$ ,  $V_{\text{OL}}$  at Q, or  $I_{\text{OS}}$  at  $\overline{Q}$ .

6. Quiescent ICC is measured (after clearing) with 4.5 V applied to all clear and A inputs, B inputs grounded, all outputs open and  $R_{ext}$  = 25 k $\Omega$ .  $R_{int}$  of '122 is open.

#### switching characteristics, VCC = 5 V, TA = 25°C, see note 8

DADAMETTO #	FROM	то		′	122, ′1	30		′123			
PARAMETER¶	(INPUT)	(OUTPUT)	TEST CON	MIN	TYP	MAX	MIN	TYP	MAX	רואט	
<sup>t</sup> PLH	A	Q				22	33		22	33	
	В					19	28		19	28	ns
<sup>t</sup> PHL	A	₫	C <sub>ext</sub> = 0,	$R_{ext} = 5 k\Omega$ ,		30	40		30	40	
	В		C <sub>1</sub> = 15 pF,	$R_1 = 400 \Omega$		27	36		27	36	ns
t <sub>PHL</sub>	Clear	<u> </u>	· · · · · · · · · · · · · · · · · · ·	11 400 32		18	27		18	27	
tPLH						30	40		30	40	ns
t <sub>WQ</sub> (min)	A or B	Q				45	65		45	76	ns
<sup>t</sup> wQ	A or B	a	$C_{ext} = 1000 pF,$ $C_{L} = 15 pF,$	$R_{ext} = 10 \text{ k}\Omega$ , $R_1 = 400 \Omega$	3.08	3.42	3.76	2.76	3,03	3.37	μs

TtpLH = propagation delay time, low-to-high-level output

NOTE 8: Load circuits and voltage waveforms are shown in Section 1.



 $<sup>^{\</sup>ddagger}$  All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25 °C.

<sup>§</sup> Not more than one output should be shorted at a time.

<sup>7.</sup> ICC is measured in the triggered state with 2.4 V applied to all clear and B inputs, A inputs grounded, all outputs open,  $C_{ext} = 0.02 \,\mu\text{F}$ , and  $R_{ext} = 25 \,\text{k}\Omega$ .  $R_{int}$  of '122 is open.

tpHL = propagation delay time, high-to-low-level output

 $t_{WQ}$  = duration of pulse at output Q.

#### SN54LS122, SN54LS123, SN74LS122, SN74LS123 RETRIGGERABLE MONOSTABLE MULTIVIBRATORS

SDLS043 - DECEMBER 1983 - REVISED MARCH 1988

#### recommended operating conditions

		SN54LS	3'		SN74LS	3'	
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC</sub>	4.5	5	5.5	4.75	5	5.25	٧
High-level output current, IOH			-400			-400	μА
Low-level output current, IOL			4			8	mA
Pulse duration, t <sub>W</sub>	40			40			ns
External timing resistance, R <sub>ext</sub>	5		180	5		260	kΩ
External capacitance, C <sub>ext</sub>	No	restrict	tion	No	restrict	ion	
Wiring capacitance at R <sub>ext</sub> /C <sub>ext</sub> terminal			50			50	pF
Operating free-air temperature, TA	-55		125	0		70	°C

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEC	T CONDITIONS†			SN54LS	•		SN74LS	,	
	FARAMETER	1 53	T CONDITIONS,		MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIH	High-level input voltage				2			2			V
VIL	Low-level input voltage						0.7			0.8	V
VIK	Input clamp voltage	V <sub>CC</sub> = MIN,	I <sub>I</sub> = -18 mA				-1.5			-1.5	V
Vон	High-level output voltage	V <sub>CC</sub> = MIN, V <sub>IL</sub> = V <sub>IL</sub> max	$V_{1H} = 2 V$ , $I_{OH} = -400 \mu A$		2.5	3.5		2.7	3.5		V
VOL	Low-level output voltage	V <sub>CC</sub> = MIN, V <sub>IL</sub> = V <sub>IL</sub> max	V <sub>IH</sub> = 2 V,	I <sub>OL</sub> = 4 mA		0.25	0.4		0.25 0.35	0.4	٧
l <sub>1</sub>	Input current at maximum input voltage	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 7 V				0.1			0.1	mA
Ιιн	High-level input current	VCC = MAX,	V <sub>1</sub> = 2.7 V				20			20	μΑ
IL	Low-level input current	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0.4 V				-0.4			-0.4	mA
los	Short-circuit output current§	V <sub>CC</sub> = MAX			-20		-100	-20		-100	mA
lcc	Supply current (quiescent or triggered)	V <sub>CC</sub> = MAX,	See Note 13	'LS122 'LS123		6 12	11 20		6 12	11 20	mA

<sup>&</sup>lt;sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTES: 12. To measure VOH at Q, VOL at Q, or IOS at Q, ground Rext/Cext, apply 2 V to B and clear, and pulse A from 2 V to 0 V.

#### switching characteristics, VCC = 5 V, TA = 25°C (see note 8)

PARAMETER¶	FROM (INPUT)	TO (OUTPUT)	TEST CON	DITIONS	MIN	TYP	MAX	UNIT
tout	Α	α				23	33	
<sup>t</sup> PLH	В	u u				23	44	ns
tPHL	Α	۵	C -0	D - 5 1:0		32	45	
PHL	В	ď	C <sub>ext</sub> = 0, C <sub>L</sub> = 15 pF,	$R_{ext} = 5 k\Omega$ , $R_{L} = 2 k\Omega$		34	56	ns
tPHL.	Clear	Q	CL = 15 pr,	H = 2 K32		20	27	
<sup>t</sup> PLH	Cieal	ā				28	45	ns
t <sub>wQ</sub> (min)	A or B	Q				116	200	ns
twQ	A or B	Q	C <sub>ext</sub> = 1000 pF, C <sub>L</sub> = 15 pF,	$R_{ext} = 10 k\Omega$ , $R_L = 2 k\Omega$	4	4.5	5	μs

TtpLH = propagation delay time, low-to-high-level output



 $<sup>^{\</sup>ddagger}$ All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25 °C.

<sup>§</sup>Not more than one output should be shorted at a time and duration of the short-circuit should not exceed one second.

<sup>13.</sup> With all outputs open and 4.5 V applied to all data and clear inputs. ICC is measured after a momentary ground, then 4.5 V, is applied to A or B inputs.

 $t_{\mbox{\footnotesize{PHL}}}$  = propagation delay time, high-to-low-level output

 $t_{WQ}$  = duration of pulse at output Q.

NOTE 8: Load circuits and voltage waveforms are shown in Section 1.

#### TYPICAL APPLICATION DATA FOR '122, '123, '130

For pulse durations when  $C_{ext} \leq 1000$  pF, see Figure 4.

The output pulse duration is primarily a function of the external capacitor and resistor. For  $C_{ext} > 1000 \ pF$ , the output pulse duration ( $t_W$ ) is defined as:

$$t_W = K \cdot R_T \cdot C_{ext} \left( 1 + \frac{0.7}{R_T} \right)$$

where

K is 0.32 for '122, 0.28 for '123 and '130

 $R_T$  is in  $k\Omega$  (internal or external timing resistance.)

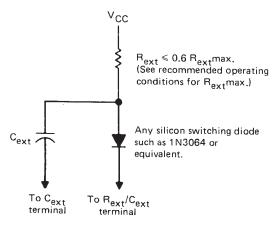
Cext is in pF

tw is in ns

To prevent reverse voltage across  $C_{\text{ext}}$ , it is recommended that the method shown in Figure 2 be employed when using electrolytic capacitors and in applications utilizing the clear function. In all applications using the diode, the pulse duration is:

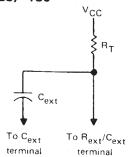
$$t_{W} = K_{D} \cdot R_{T} \cdot C_{ext} \left( 1 + \frac{0.7}{R_{T}} \right)$$

Kp is 0.28 for '122, 0.25 for '123 and '130



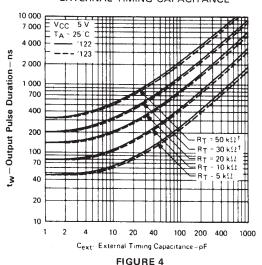
TIMING COMPONENT CONNECTIONS WHEN  $C_{ext} \geq 1000 \; \text{pF AND CLEAR IS USED}$  FIGURE 2

Applications requiring more precise pulse durations (up to 28 seconds) and not requiring the clear feature can best be satisfied with the '121.



TIMING COMPONENT CONNECTIONS FIGURE 3

TYPICAL OUTPUT PULSE DURATION vs
EXTERNAL TIMING CAPACITANCE



<sup>†</sup>These values of resistance exceed the maximum recommended for use over the full temperature range of the SN54' circuits.

SDLS043 - DECEMBER 1983 - REVISED MARCH 1988

#### TYPICAL APPLICATION DATA FOR 'LS122, 'LS123

The basic output pulse duration is essentially determined by the values of external capacitance and timing resistance. For pulse durations when  $C_{\text{ext}} \le 1000 \text{ pF}$ , use Figure 6, or use Figure 7 where the pulse duration may be defined as:

$$t_W = K \cdot R_T \cdot C_{ext}$$

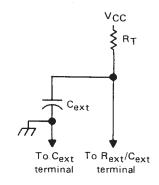
When  $C_{ext} \ge 1 \mu F$ , the output pulse width is defined as:

$$t_W = 0.33 \cdot R_T \cdot C_{ext}$$

For the above two equations, as applicable;

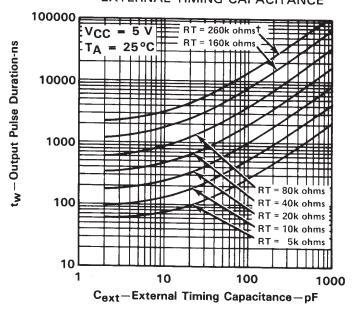
K is multiplier factor, see Figure 7 RT is in  $k\Omega$  (internal or external timing resistance)  $C_{\text{ext}}$  is in pF  $t_{\text{W}}$  is in ns

For maximum noise immunity, system ground should be applied to the  $C_{\text{ext}}$  node, even though the  $C_{\text{ext}}$  node is already tied to the ground lead internally. Due to the timing scheme used by the 'LS122 and 'LS123, a switching diode is not required to prevent reverse biasing when using electolytic capacitors.



TIMING COMPONENT CONNECTIONS
FIGURE 5

# 'LS122, 'LS123 TYPICAL OUTPUT PULSE DURATION vs EXTERNAL TIMING CAPACITANCE



<sup>†</sup>This value of resistance exceeds the maximum recommended for use over the full temperature range of the SN54LS circuits.

FIGURE 6



# TYPICAL APPLICATION DATA FOR 'LS122, 'LS123†



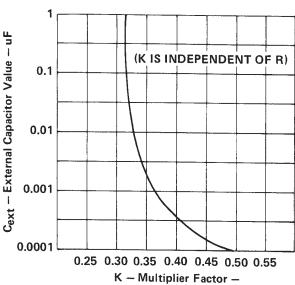
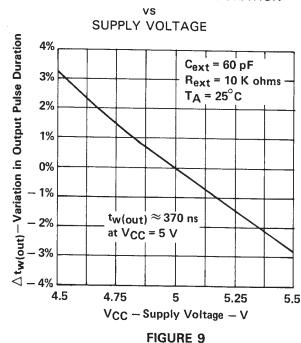
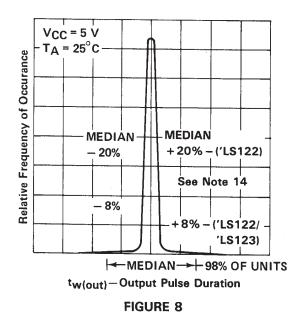


FIGURE 7

#### VARIATION IN OUTPUT PULSE DURATION



# DISTRIBUTION OF UNITS vs OUTPUT PULSE DURATION



VARIATION IN OUTPUT PULSE DURATION

#### vs FREE-AIR TEMPERATURE

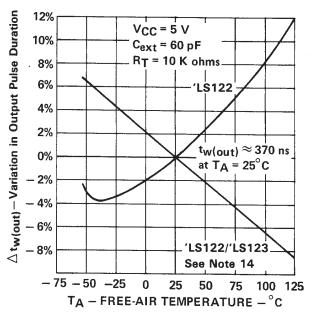


FIGURE 10

NOTE 14: For the 'LS122, the internal timing resistor, R<sub>int</sub> was used. For the 'LS122/123, an external timing resistor was used for R<sub>T</sub>.

†Data for temperatures below 0°C and above 70°C and for suply voltages below 4.75 V and above 5.25 V are applicable for SN54LS122 and SN54LS123 only.



www.ti.com

16-Oct-2025

#### **PACKAGING INFORMATION**

Orderable part number	Status (1)	Material type	Package   Pins	Package qty   Carrier	<b>RoHS</b> (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
5962-7603901VEA	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-7603901VE A SNV54LS123J
5962-7603901VEA.A	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-7603901VE A SNV54LS123J
5962-7603901VFA	Active	Production	CFP (W)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-7603901VF A SNV54LS123W
5962-7603901VFA.A	Active	Production	CFP (W)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-7603901VF A SNV54LS123W
7603901EA	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7603901EA SNJ54LS123J
7603901FA	Active	Production	CFP (W)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7603901FA SNJ54LS123W
JM38510/01203BEA	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 01203BEA
JM38510/01203BEA.A	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 01203BEA
JM38510/31401B2A	Active	Production	LCCC (FK)   20	55   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 31401B2A
JM38510/31401B2A.A	Active	Production	LCCC (FK)   20	55   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 31401B2A
JM38510/31401BEA	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 31401BEA
JM38510/31401BEA.A	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 31401BEA
JM38510/31401BFA	Active	Production	CFP (W)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 31401BFA
JM38510/31401BFA.A	Active	Production	CFP (W)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 31401BFA
M38510/01203BEA	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 01203BEA





www.ti.com 16-Oct-2025

Orderable part number	Status (1)	Material type	Package   Pins	Package qty   Carrier	<b>RoHS</b> (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
M38510/31401B2A	Active	Production	LCCC (FK)   20	55   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 31401B2A
M38510/31401BEA	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 31401BEA
M38510/31401BFA	Active	Production	CFP (W)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 31401BFA
SN54123J	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54123J
SN54123J.A	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54123J
SN54LS123J	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54LS123J
SN54LS123J.A	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54LS123J
SN74123N	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74123N
SN74123N.A	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74123N
SN74LS122D	Obsolete	Production	SOIC (D)   14	-	-	Call TI	Call TI	0 to 70	LS122
SN74LS122DR	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS122
SN74LS122DR.A	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS122
SN74LS122DR.B	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS122
SN74LS122DRE4	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS122
SN74LS122N	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS122N
SN74LS122N.A	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS122N
SN74LS122NSR	Active	Production	SOP (NS)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS122
SN74LS122NSR.A	Active	Production	SOP (NS)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS122
SN74LS123D	Active	Production	SOIC (D)   16	40   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS123
SN74LS123D.A	Active	Production	SOIC (D)   16	40   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS123
SN74LS123DBR	Active	Production	SSOP (DB)   16	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-	LS123
SN74LS123DBR.A	Active	Production	SSOP (DB)   16	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS123
SN74LS123DE4	Active	Production	SOIC (D)   16	40   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS123
SN74LS123DR	Active	Production	SOIC (D)   16	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS123
SN74LS123DR.A	Active	Production	SOIC (D)   16	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS123
SN74LS123DRG4	Active	Production	SOIC (D)   16	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS123
SN74LS123N	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS123N
SN74LS123N.A	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS123N





www.ti.com 16-Oct-2025

Orderable part number	Status (1)	Material type	Package   Pins	Package qty   Carrier	RoHS	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
SN74LS123NE4	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS123N
SN74LS123NSR	Active	Production	SOP (NS)   16	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS123
SN74LS123NSR.A	Active	Production	SOP (NS)   16	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS123
SN74LS123NSRG4	Active	Production	SOP (NS)   16	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS123
SNJ54123J	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54123J
SNJ54123J.A	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54123J
SNJ54123W	Active	Production	CFP (W)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54123W
SNJ54123W.A	Active	Production	CFP (W)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54123W
SNJ54LS123FK	Active	Production	LCCC (FK)   20	55   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54LS 123FK
SNJ54LS123FK.A	Active	Production	LCCC (FK)   20	55   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54LS 123FK
SNJ54LS123J	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7603901EA SNJ54LS123J
SNJ54LS123J.A	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7603901EA SNJ54LS123J
SNJ54LS123W	Active	Production	CFP (W)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7603901FA SNJ54LS123W
SNJ54LS123W.A	Active	Production	CFP (W)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7603901FA SNJ54LS123W

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

#### **PACKAGE OPTION ADDENDUM**

www.ti.com 16-Oct-2025

(6) Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

#### OTHER QUALIFIED VERSIONS OF SN54123, SN54LS123, SN54LS123-SP, SN74123, SN74LS123:

Catalog: SN74123, SN74LS123, SN54LS123

Military: SN54123, SN54LS123

Space: SN54LS123-SP

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications
- Space Radiation tolerant, ceramic packaging and qualified for use in Space-based application

## **PACKAGE MATERIALS INFORMATION**

www.ti.com 24-Jul-2025

#### TAPE AND REEL INFORMATION





	-
A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS122DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74LS122NSR	SOP	NS	14	2000	330.0	16.4	8.1	10.4	2.5	12.0	16.0	Q1
SN74LS123DBR	SSOP	DB	16	2000	330.0	16.4	8.35	6.6	2.4	12.0	16.0	Q1
SN74LS123DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS123NSR	SOP	NS	16	2000	330.0	16.4	8.1	10.4	2.5	12.0	16.0	Q1



www.ti.com 24-Jul-2025



#### \*All dimensions are nominal

7 till dillitoriolorio di o riorriiridi							
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS122DR	SOIC	D	14	2500	353.0	353.0	32.0
SN74LS122NSR	SOP	NS	14	2000	353.0	353.0	32.0
SN74LS123DBR	SSOP	DB	16	2000	353.0	353.0	32.0
SN74LS123DR	SOIC	D	16	2500	353.0	353.0	32.0
SN74LS123NSR	SOP	NS	16	2000	353.0	353.0	32.0



www.ti.com 24-Jul-2025

#### **TUBE**



#### \*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
5962-7603901VFA	W	CFP	16	25	506.98	26.16	6220	NA
5962-7603901VFA.A	W	CFP	16	25	506.98	26.16	6220	NA
JM38510/31401B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
JM38510/31401B2A.A	FK	LCCC	20	55	506.98	12.06	2030	NA
JM38510/31401BFA	W	CFP	16	25	506.98	26.16	6220	NA
JM38510/31401BFA.A	W	CFP	16	25	506.98	26.16	6220	NA
M38510/31401B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
M38510/31401BFA	W	CFP	16	25	506.98	26.16	6220	NA
SN74123N	N	PDIP	16	25	506	13.97	11230	4.32
SN74123N	N	PDIP	16	25	506	13.97	11230	4.32
SN74123N.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74123N.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS122N	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS122N	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS122N.A	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS122N.A	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS123D	D	SOIC	16	40	507	8	3940	4.32
SN74LS123D.A	D	SOIC	16	40	507	8	3940	4.32
SN74LS123DE4	D	SOIC	16	40	507	8	3940	4.32
SN74LS123N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS123N.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS123NE4	N	PDIP	16	25	506	13.97	11230	4.32
SNJ54123W	W	CFP	16	25	506.98	26.16	6220	NA
SNJ54123W.A	W	CFP	16	25	506.98	26.16	6220	NA
SNJ54LS123FK	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54LS123FK.A	FK	LCCC	20	55	506.98	12.06	2030	NA



SOP



- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing
- per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.



SOF



#### NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOF



#### NOTES: (continued)

- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.





SMALL OUTLINE INTEGRATED CIRCUIT



- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
- 5. Reference JEDEC registration MS-012, variation AB.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



# D (R-PDS0-G16)

#### PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.





SMALL OUTLINE PACKAGE



- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
  4. Reference JEDEC registration MO-150.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.



#### **MECHANICAL DATA**

#### NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



# W (R-GDFP-F16)

#### CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP2-F16



8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



**INSTRUMENTS** www.ti.com

#### 14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# N (R-PDIP-T\*\*)

#### PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



#### IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you fully indemnify TI and its representatives against any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale, TI's General Quality Guidelines, or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products. Unless TI explicitly designates a product as custom or customer-specified, TI products are standard, catalog, general purpose devices.

TI objects to and rejects any additional or different terms you may propose.

Copyright © 2025, Texas Instruments Incorporated

Last updated 10/2025